SFT-25R-WF (CRI > 80)

High Power White LEDs



Features

With Luminus' advanced chip and packaging technologies, SFT-25R-W maximizes the Candela/Lumen K-Factor for high optical performance in directional lighting:

- A small emitter enables high intensity, long beam distance and small optics.
- A patented round emitter, in comparison with a square emitter, enables better uniformity and higher intensity in beam spots.
- A flat window, in comparison with a domed cover, allows the optics to be closer to the emitter to achieve higher intensity and longer beam distance.

In addition, Luminus phosphor-on-chip technology's high uniformity of color over radiation angle enables superior beam spot light quality.

- Package Size: 3535
- Maximum Drive Current: 5 A
- Color Temperature: 2200K - 6500K
- Color Rendering Index: > 80
- Low thermal resistance: 0.8 °C/W
- ANSI-compatible chromaticity bins
- Electrically isolated thermal path
- 8 kV HBM ESD rating per ANSI/ESDA/JEDEC JS-001

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Applications

- Stage and Studio Lighting
- Stadium and Sports Field Lighting
- Roadway and Outdoor Lighting
- Landscape Lighting
- Garage and Canopy Lights
- High / Low Bay Industrial Lighting
- Track Light
- Spotlight
- Wall Washer
- Task Light

Ordering Information

Ordering Part Numbers[1]

CRI	CCT	Luminous Flux		Ordering Part Number[3]		
		Minimum Flux Bin[1]	Minimum Flux[2]	Chromaticity Bin Kit 2-Step Ellipse[3]	Chromaticity Bin Kit 3-Step Ellipse[3]	Chromaticity Bin Kit ANSI Centers[3]
> 80	2200K	D8	375 lm	-	-	SFT-25R-WF22-AV2-D8222
	2700K	F3	465 lm	SFT-25R-WF27-AV2-F327E2	SFT-25R-WF27-AV2-F327E3	SFT-25R-WF27-AV2-F3272
	3000K	F4	490 lm	SFT-25R-WF30-AV2-F430E2	SFT-25R-WF30-AV2-F430E3	SFT-25R-WF30-AV2-F4302
	3500K	F4	490 lm	SFT-25R-WF35-AV2-F435E2	SFT-25R-WF35-AV2-F435E3	SFT-25R-WF35-AV2-F4352
	4000K	F5	520 lm	SFT-25R-WF40-AV2-F540E2	SFT-25R-WF40-AV2-F540E3	SFT-25R-WF40-AV2-F5402
	5000K	F5	520 lm	-	SFT-25R-WF50-AV2-F550E3	SFT-25R-WF50-AV2-F5502
	5700K	F5	520 lm		SFT-25R-WF57-AV2-F557E3	SFT-25R-WF57-AV2-F5572
	6500K	F5	520 lm		SFT-25R-WF65-AV2-F565E3	SFT-25R-WF65-AV2-F5652

Part Number Nomenclature

SFT **25R** **W<xyy>** **AV2** **<ffcccc>**

Product Family	Chip Area	Color	Package Configuration	Bin Kit
S: Surface Mount **F**: Flat-top window-less package **T**: Single die emitter	**25**: 2.5 mm^2 **R**: Round Shape	**W**: White <**x**> CRI Category Code **F**: CRI > 80 <**yy**> Color Temperature **22**: 2200K **65**: 6500K	**AV2**: 3535 package code	<**ff**> Minimum Flux Bin, <**cccc**> Chromaticity Bin Kit Refer to 'Binning Structure' tables for details

Notes:

1. The Ordering Part Number specifies the Minimum Flux Bin in shipment; higher flux bins may be shipped without advance notice. Please refer to 'Binning Structure' table for details of all flux bins.
2. Product test condition: I_f = 1500 mA, T_j = 85°C.
3. Shipments always adhere to the color bins specified in each Chromaticity Bin Kit. See 'Chromaticity Bin Kit Codes' table for the color bins included in each bin kit.

Binning Structure

Luminous Flux Bins[1, 2]

Flux Bin	Binning @ 1500 mA			Correlated Minimum Flux (lm) @ T_j = 85°C[2]			
	T_j = 85°C		T_j = 25°C				
	Minimum Flux (lm)	Maximum Flux (lm)	Minimum Flux (lm)	1000 mA	3000 mA	4000 mA	5000 mA
D7	355	375	398	252	614	756	873
D8	375	395	420	266	649	799	923
D9	395	415	442	280	683	841	972
F1	415	440	465	295	718	884	1021
F2	440	465	493	312	761	937	1082
F3	465	490	521	330	804	990	1144
F4	490	520	549	348	848	1044	1205
F5	520	550	582	369	900	1108	1279
F6	550	580	616	391	952	1172	1353
F7	580	610	650	412	1003	1235	1427

Forward Voltage Bins[3]

Voltage Bin	Binning @ 1500 mA, T_j = 85°C	
	Minimum Voltage (V)	Maximum Voltage (V)
VJ	2.7	2.9
VK	2.9	3.1
VL	3.1	3.3

Notes:

1. LEDs are measured at 25°C ambient temperature with 1500 mA 20 ms single pulse. The measured values are correlated to values at 85°C junction temperature (T_j). Luminus maintains a ±6% tolerance on flux measurement.
2. Flux values at other junction temperature (T_j) and/or forward current conditions are calculated and for reference only.
3. Individual bins are not orderable.

Binning Structure

Chromaticity Binning Coordinates (2-Step & 3-Step Ellipse)

CCT	Center Point		2-Step Ellipse		3-Step Ellipse		Angle
	CIEx	CIEy	a	b	a	b	
2700K	0.4582	0.4099	0.0054	0.0028	0.0081	0.0042	53.42°
3000K	0.4338	0.4030	0.0056	0.0027	0.0083	0.0041	53.20°
3500K	0.4080	0.3916	0.0062	0.0028	0.0093	0.0041	54.00°
4000K	0.3825	0.3798	0.0063	0.0027	0.0094	0.0040	53.43°
5000K	0.3447	0.3553	-		0.0081	0.0035	59.60°
5700K	0.3287	0.3417			0.0072	0.0032	59.09°
6500K	0.3123	0.3282			0.0067	0.0029	58.57°

Binning Structure

Chromaticity Binning Coordinates (ANSI Centers)

CCT	Bin	CIEx	CIEy	Bin	CIEx	CIEy	Bin	CIEx	CIEy	Bin	CIEx	CIEy
2200K	LA3	0.4890	0.4061	LB4	0.4954	0.4155	LC1	0.5014	0.4153	LD2	0.4949	0.4059
		0.4954	0.4155		0.5017	0.4249		0.5079	0.4247		0.5014	0.4153
		0.5014	0.4153		0.5079	0.4247		0.514	0.4245		0.5074	0.4151
		0.4949	0.4059		0.5014	0.4153		0.5074	0.4151		0.5007	0.4057
2700K	JA3	0.4475	0.3994	JB4	0.4523	0.4085	JC1	0.4582	0.4099	JD2	0.4532	0.4008
		0.4523	0.4085		0.4573	0.4178		0.4634	0.4193		0.4582	0.4099
		0.4582	0.4099		0.4634	0.4193		0.4695	0.4207		0.4641	0.4112
		0.4532	0.4008		0.4582	0.4099		0.4641	0.4112		0.4589	0.4021
3000K	HA3	0.4242	0.3919	HB4	0.4281	0.4006	HC1	0.4342	0.4028	HD2	0.4300	0.3939
		0.4281	0.4006		0.4322	0.4096		0.4385	0.4119		0.4342	0.4028
		0.4342	0.4028		0.4385	0.4119		0.4449	0.4141		0.4403	0.4049
		0.4300	0.3939		0.4342	0.4028		0.4403	0.4049		0.4359	0.3960
3500K	GA3	0.3981	0.3800	GB4	0.4010	0.3882	GC1	0.4080	0.3916	GD2	0.4048	0.3832
		0.4010	0.3882		0.4040	0.3966		0.4113	0.4001		0.4080	0.3916
		0.4080	0.3916		0.4113	0.4001		0.4186	0.4037		0.4150	0.3950
		0.4048	0.3832		0.4080	0.3916		0.4150	0.3950		0.4116	0.3865
4000K	FA3	0.3744	0.3685	FB4	0.3763	0.3760	FC1	0.3825	0.3798	FD2	0.3804	0.3721
		0.3763	0.3760		0.3782	0.3837		0.3847	0.3877		0.3825	0.3798
		0.3825	0.3798		0.3847	0.3877		0.3912	0.3917		0.3887	0.3836
		0.3804	0.3721		0.3825	0.3798		0.3887	0.3836		0.3863	0.3758

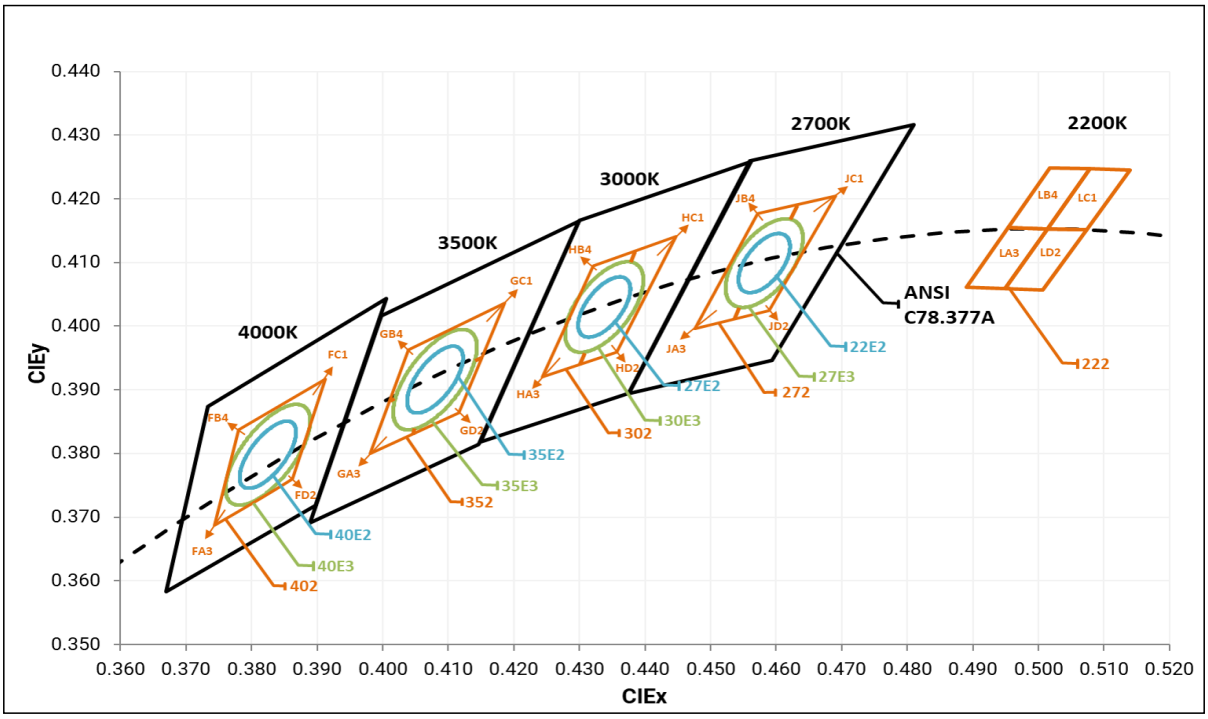
Binning Structure

Chromaticity Binning Coordinates (ANSI Centers)

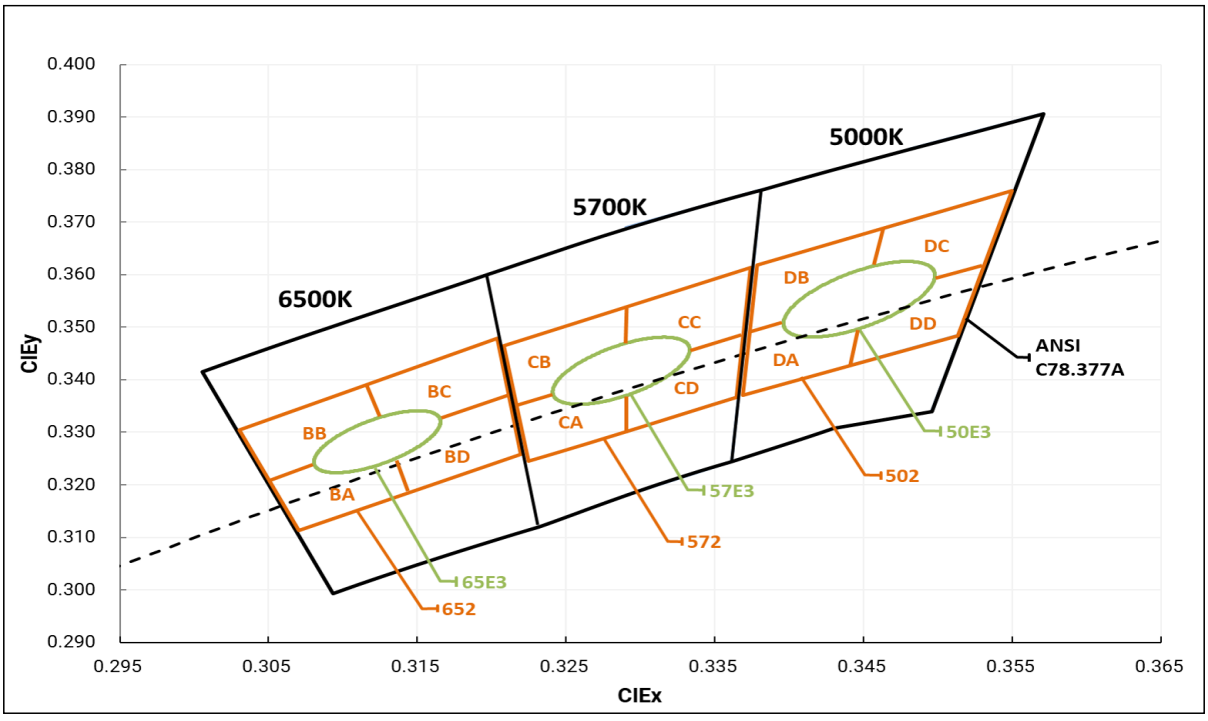
CCT	Bin	CIEx	CIEy	Bin	CIEx	CIEy	Bin	CIEx	CIEy	Bin	CIEx	CIEy
5000K	DA	0.3396	0.3510	DB	0.3457	0.3617	DC	0.3497	0.3591	DD	0.3446	0.3497
		0.3371	0.3490		0.3463	0.3687		0.3533	0.3620		0.3440	0.3427
		0.3366	0.3369		0.3376	0.3616		0.3551	0.3760		0.3515	0.3487
		0.3440	0.3427		0.3371	0.3490		0.3463	0.3687		0.3533	0.3620
		0.3446	0.3497		0.3396	0.3510		0.3457	0.3617		0.3497	0.3591
5700K	CA	0.3241	0.3373	CB	0.3290	0.3469	CC	0.3333	0.3456	CD	0.3290	0.3370
		0.3215	0.3350		0.3290	0.3538		0.3371	0.3490		0.3290	0.3300
		0.3222	0.3243		0.3207	0.3462		0.3376	0.3616		0.3366	0.3369
		0.3290	0.3300		0.3215	0.3350		0.3290	0.3538		0.3371	0.3490
		0.3290	0.3370		0.3241	0.3373		0.3290	0.3469		0.3333	0.3456
6500K	BA	0.3081	0.3241	BB	0.3124	0.3328	BC	0.3165	0.3326	BD	0.3136	0.3251
		0.3048	0.3207		0.3115	0.3391		0.3213	0.3373		0.3144	0.3186
		0.3068	0.3113		0.3028	0.3304		0.3205	0.3481		0.3221	0.3261
		0.3144	0.3186		0.3048	0.3207		0.3115	0.3391		0.3213	0.3373
		0.3136	0.3251		0.3081	0.3241		0.3124	0.3328		0.3165	0.3326

Binning Structure

Chromaticity Binning Diagram (Warm White)[1, 2, 3]



Chromaticity Binning Diagram (Cool White)[1, 2, 3]



Binning Structure

Chromaticity Bin Kit Codes[1, 2, 3]

CCT	2-Step Ellipse		3-Step Ellipse		ANSI Centers	
	Bin Kit Code	Chromaticity Bins	Bin Kit Code	Chromaticity Bins	Bin Kit Code	Chromaticity Bins
2200K	-		-		222	LA3, LB4, LC1, LD2
2700K	27E2	27E2	27E3	27E2, 27E3	272	27E3, JA3, JB4, JC1, JD2
3000K	30E2	30E2	30E3	30E2, 30E3	302	30E3, HA3, HB4, HC1, HD2
3500K	35E2	35E2	35E3	35E2 ,35E3	352	35E3, GA3, GB4, GC1, GD2
4000K	40E2	40E2	40E3	40E2, 40E3	402	40E3, FA3, FB4, FC1, FD2
5000K	-		50E3	50E3	502	50E3, DA, DB, DC, DD
5700K			57E3	57E3	572	57E3, CA, CB, CC, CD
6500K			65E3	65E3	652	65E3, BA, BB, BC, BD

Notes:

1. LED chromaticity is measured and binned at 25°C ambient temperature with 1500 mA 20 ms single pulse.
2. Luminus maintains a tolerance of ±0.005 on Chromaticity (CIEx, CIEy) measurement.
3. Chromaticity binning is based on CIEx and CIEy coordinates only. CCT values shown in the datasheet are for informational purposes and do not represent binning criteria.

Characteristics

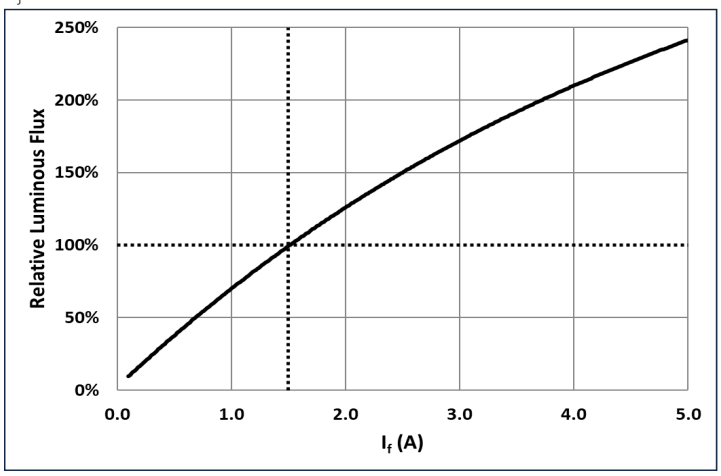
Parameter (I_f = 1500 mA, T_j = 85°C)		**Symbol**	**Value**	**Unit**
Color Rendering Index[1]		CRI	> 80	
Forward Voltage	Minimum	$V_{f\ min}$	2.7	V
	Typical	$V_{f\ typ}$	2.9	
	Maximum	$V_{f\ max}$	3.3	
Viewing Angle[2]	**2200K - 4000K**	$2\theta_{1/2}$	116	°
	5000K - 6500K		117	
Temperature Coefficient of Voltage		Δ_{Vf}/Δ_T	-1.4	mV/°C
Electrical Thermal Resistance (Junction to Solder Point)[3]		$R_{th\ JS\ elec}$	0.8	°C/W

Notes:

1. Luminus maintains a tolerance of ±2 on Color Rendering Index (CRI) measurement.
2. Please contact Luminus Sales regarding the details of Viewing Angle vs Chromaticity.
3. Thermal measurements are in accordance with JEDEC 51-14.

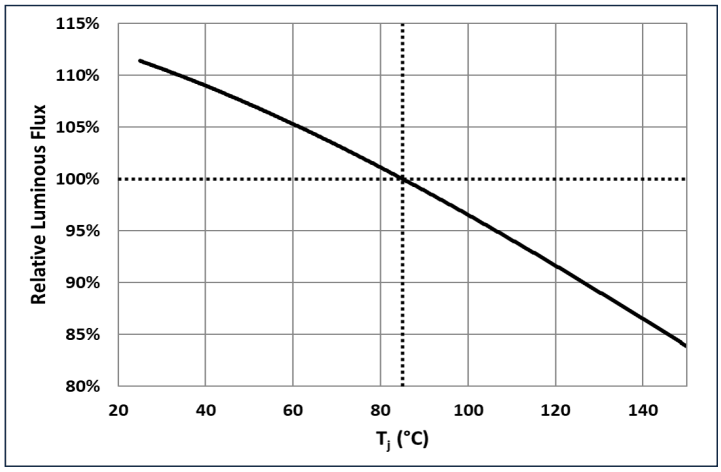
Relative Luminous Flux vs Forward Current

T_j = 85°C (2200K - 4000K)



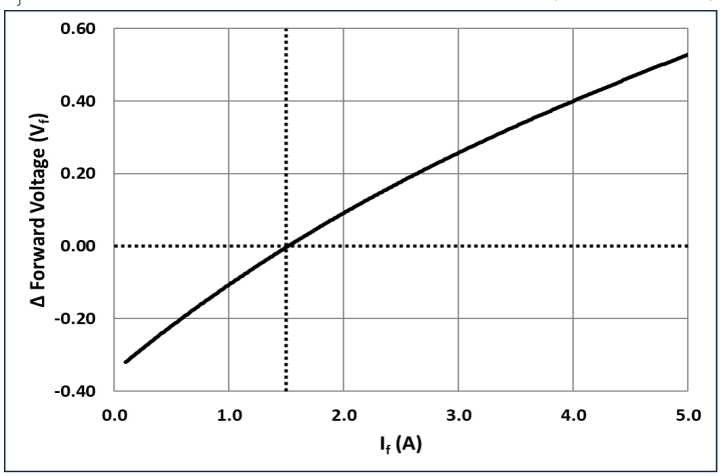
Relative Luminous Flux vs Temperature

I_f = 1.5 A (2200K - 4000K)



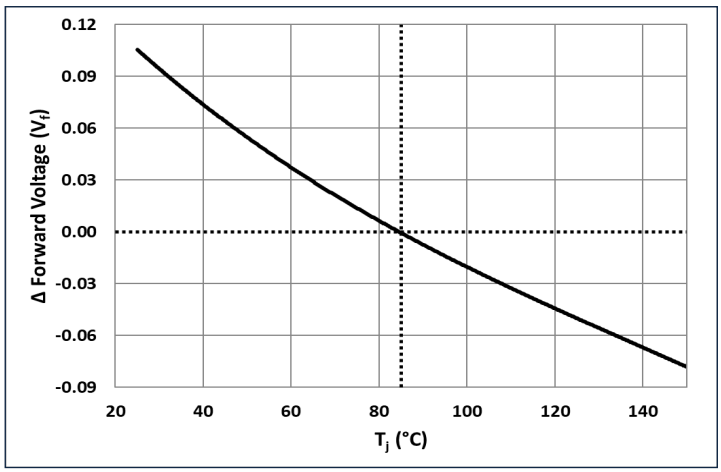
Forward Voltage Shift vs Forward Current

T_j = 85°C (2200K - 4000K)



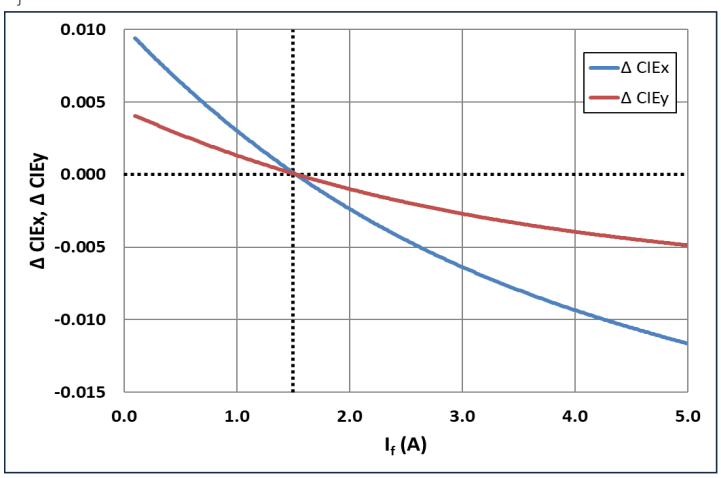
Forward Voltage Shift vs Temperature

I_f = 1.5 A (2200K - 4000K)



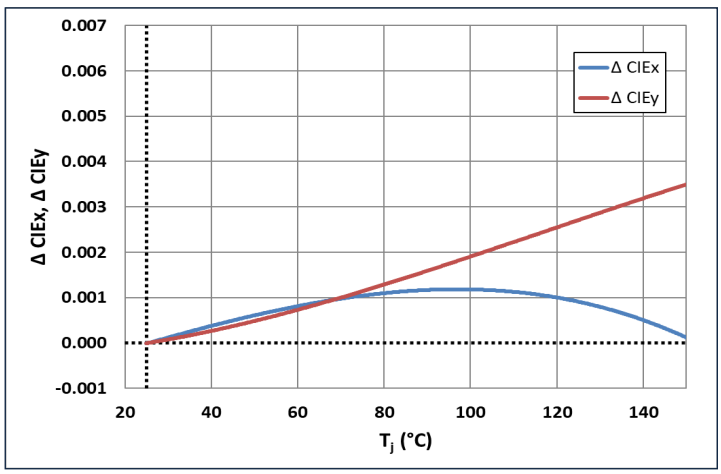
Relative Chromaticity vs Forward Current

T_j = 85°C (2200K - 4000K)



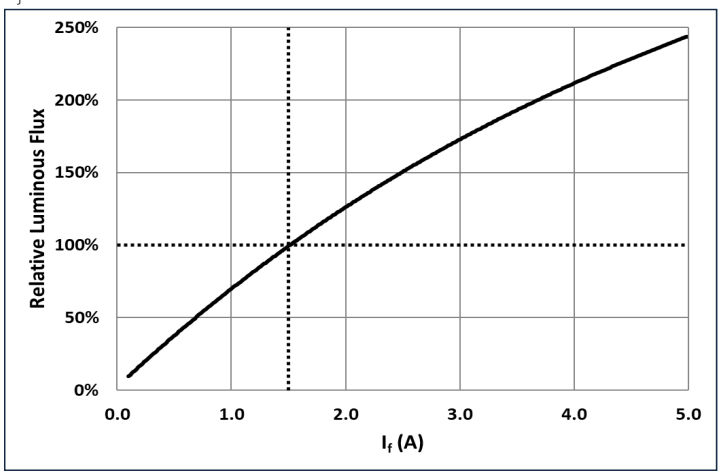
Relative Chromaticity vs Temperature

I_f = 1.5 A (2200K - 4000K)



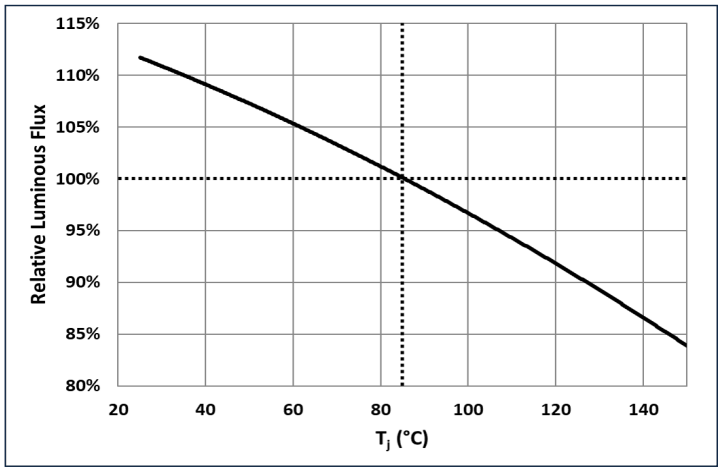
Relative Luminous Flux vs Forward Current

T_j = 85°C (5000K - 6500K)



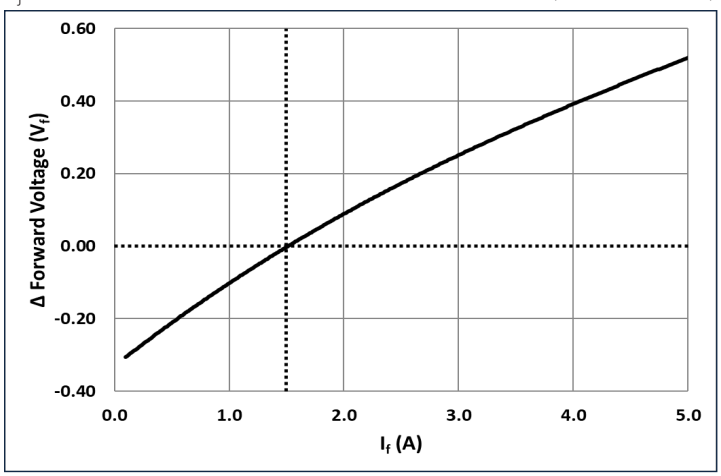
Relative Luminous Flux vs Temperature

I_f = 1.5 A (5000K - 6500K)



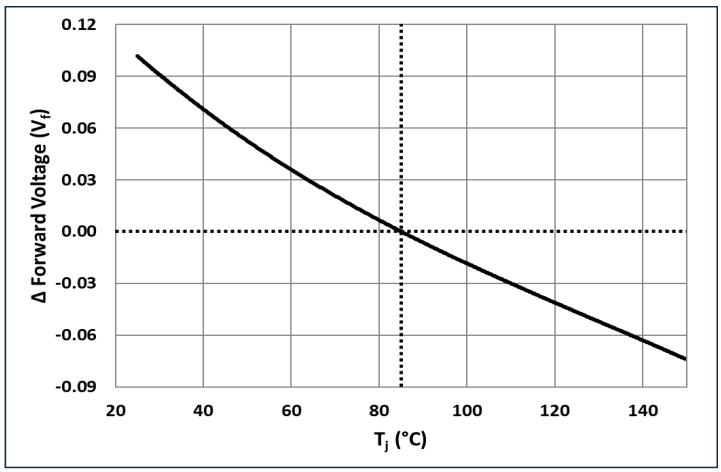
Forward Voltage Shift vs Forward Current

T_j = 85°C (5000K - 6500K)



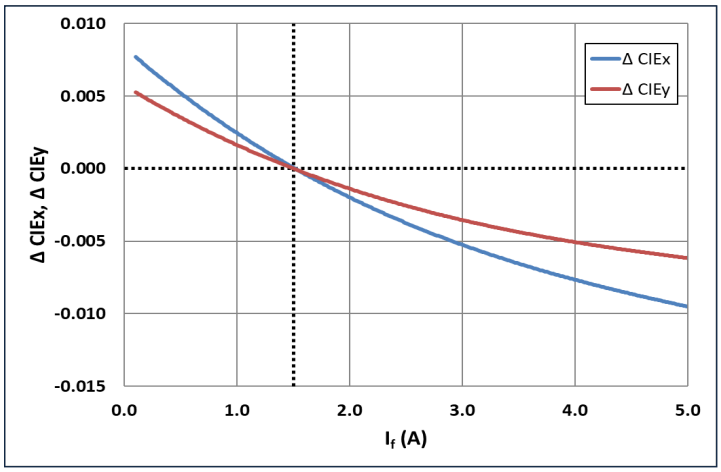
Forward Voltage Shift vs Temperature

I_f = 1.5 A (5000K - 6500K)



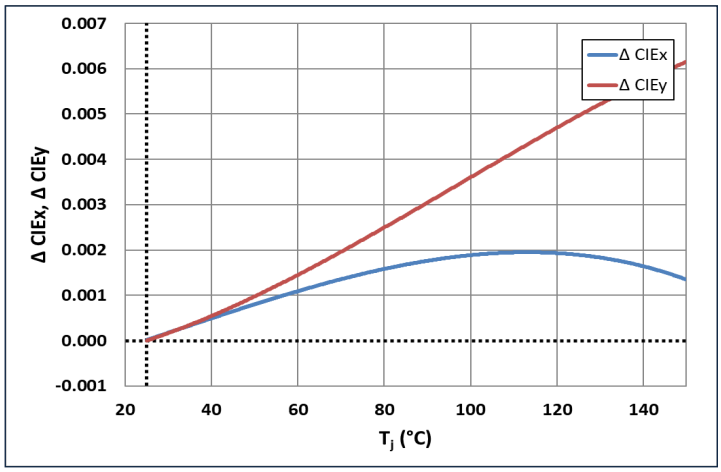
Relative Chromaticity vs Forward Current

T_j = 85°C (5000K - 6500K)



Relative Chromaticity vs Temperature

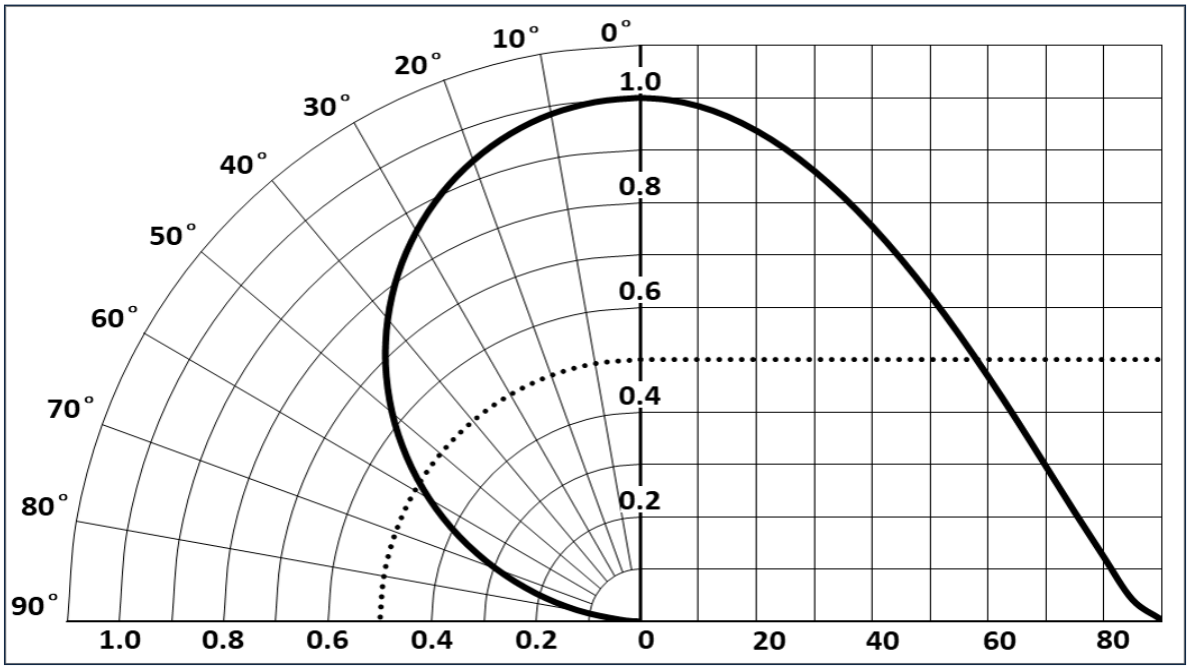
I_f = 1.5 A (5000K - 6500K)



Angular Distribution and Typical Spectrum

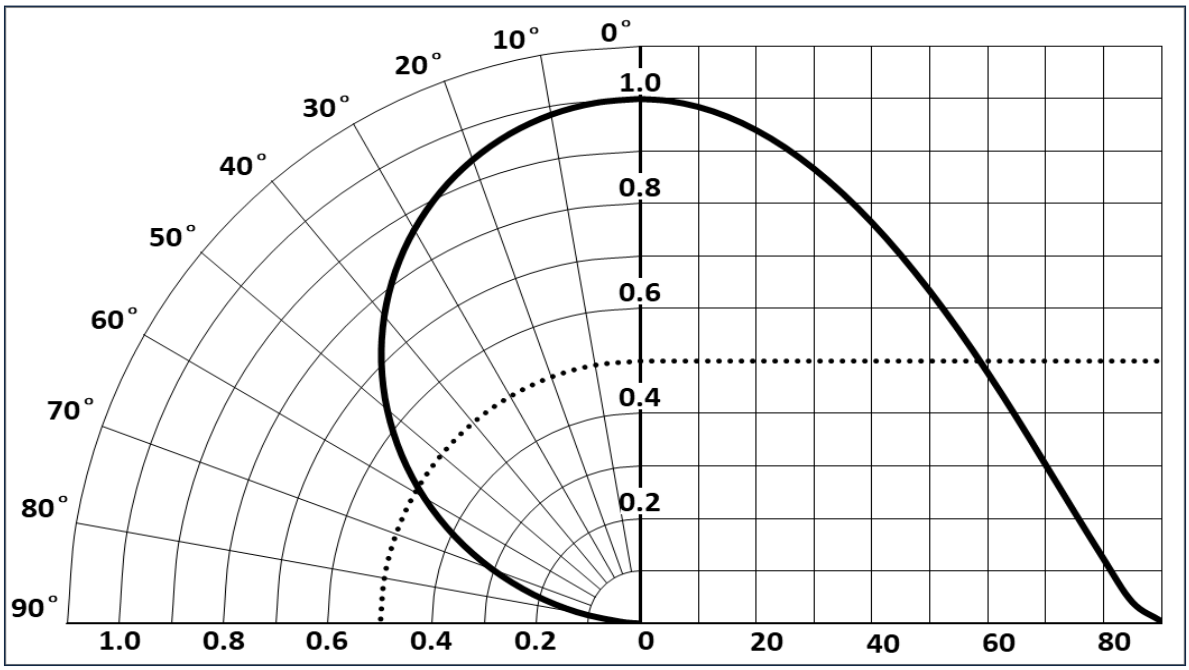
Angular Distribution (2200K - 4000K)

I_f = 1.5 A; T_j = 25°C



Angular Distribution (5000K - 6500K)

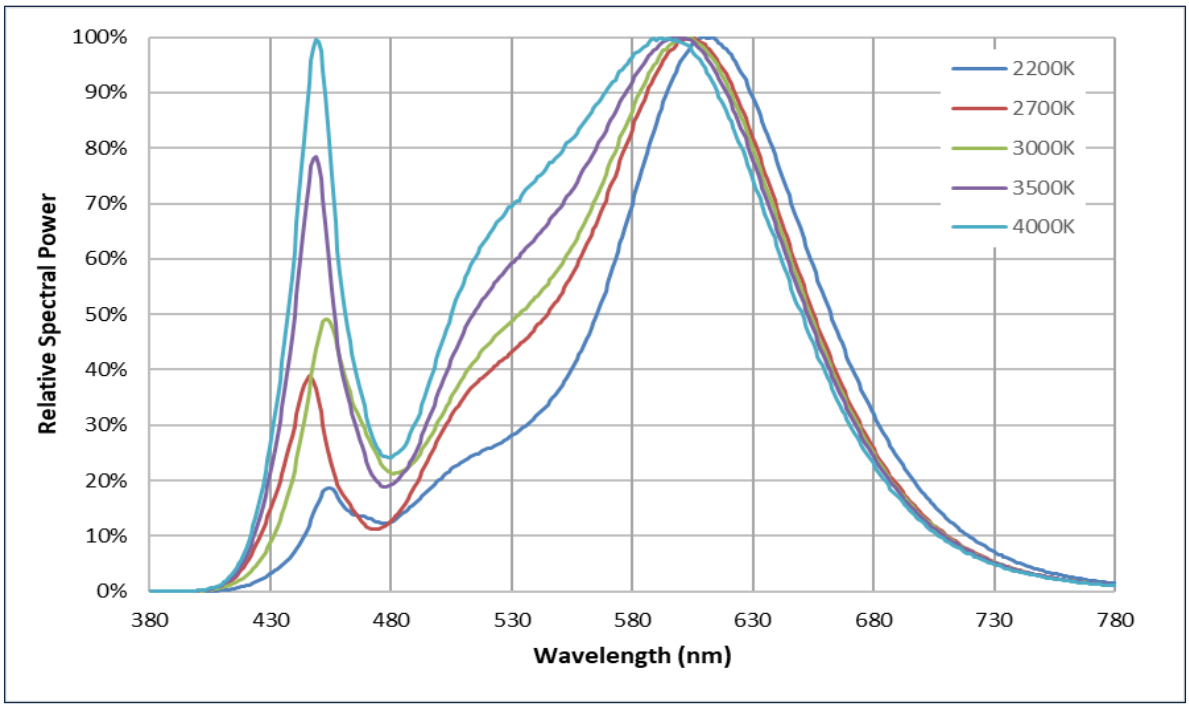
I_f = 1.5 A; T_j = 25°C



Angular Distribution and Typical Spectrum

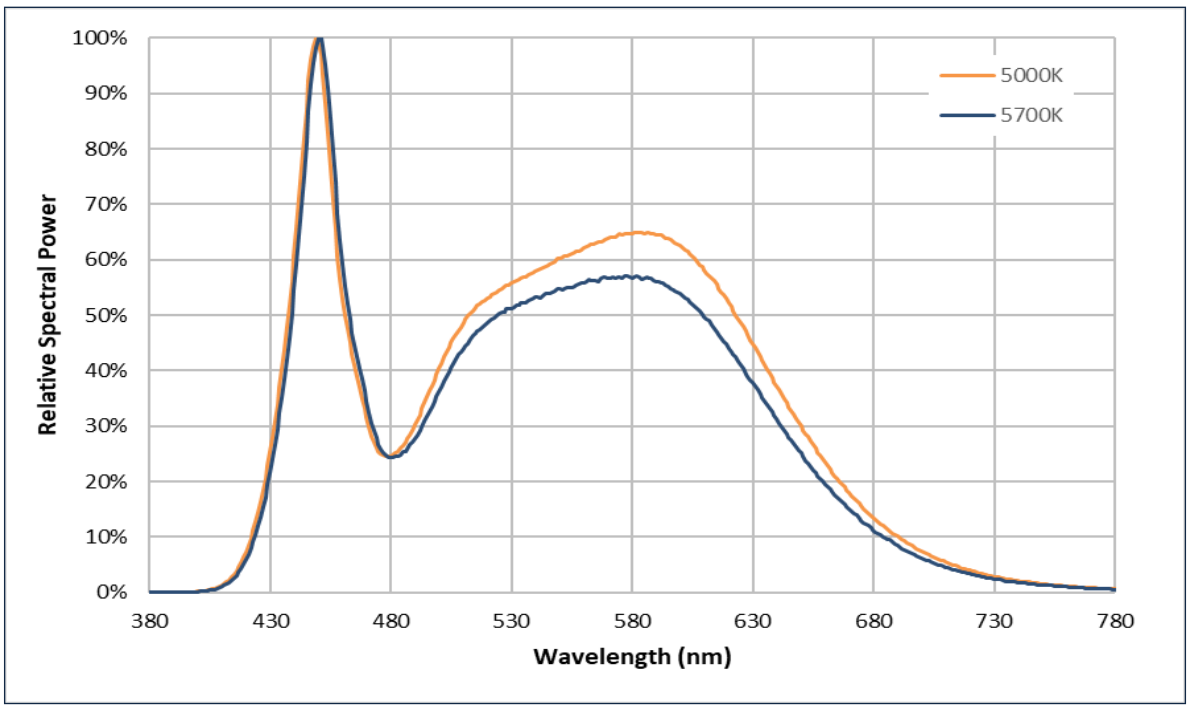
Relative Spectral Power Distribution (2200K - 4000K)

I_f = 1.5 A; T_j = 85°C



Relative Spectral Power Distribution (5000K - 5700K)

I_f = 1.5 A; T_j = 85°C



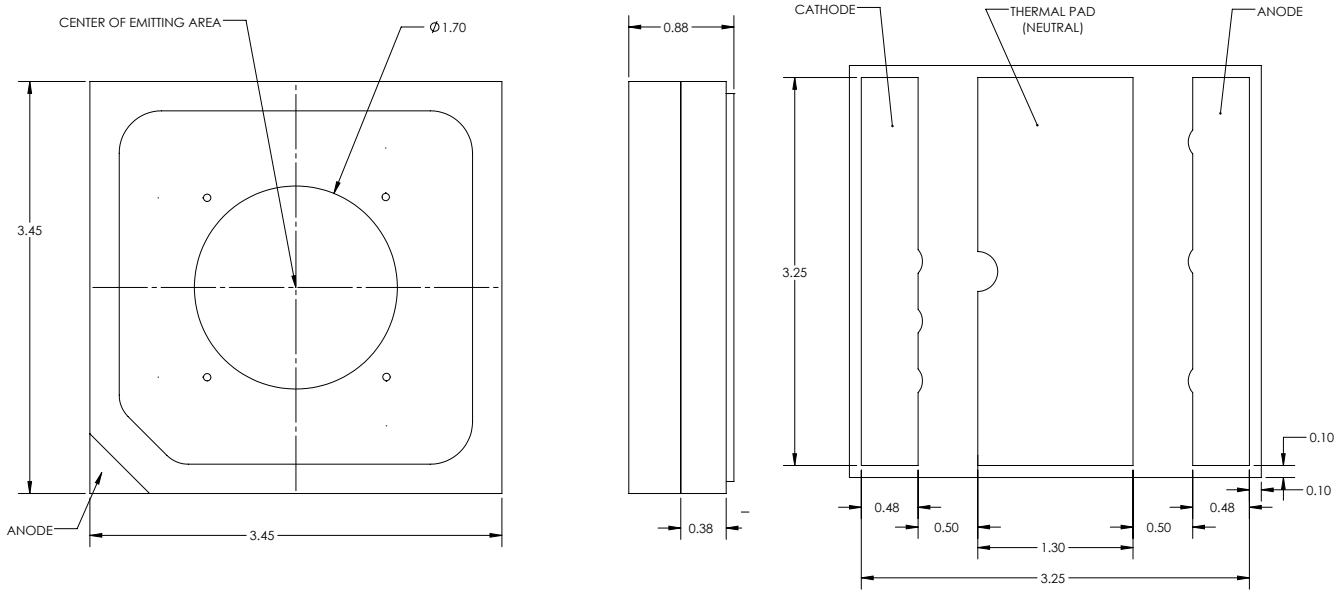
Absolute Maximum Ratings[1, 2]

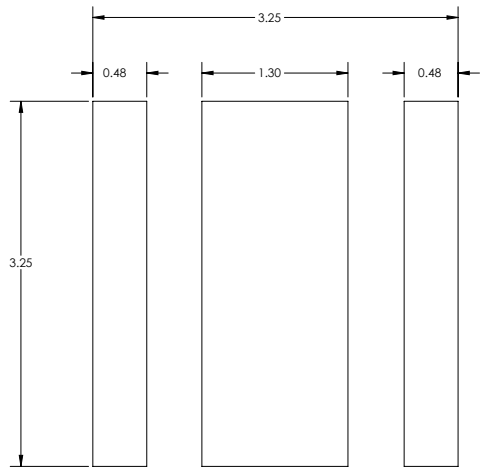
Parameter		Symbol	Values	Unit
Forward Current	Minimum	$I_{f\,min}$	0.1	A
	Maximum	$I_{f\,max}$	5.0	
Surge Current (t < 10 ms, Duty Cycle < 10%)		I_s	5.0	
Power Dissipation		P_D	18	W
Reverse Voltage		V_r	5	V
Junction Temperature		T_j	150	°C
Operating Temperature Range		T_{opr}	-40 to 100	
Storage Temperature Range		T_{stg}	-40 to 100	
ESD withstand Voltage ANSI/ESDA/JEDEC JS-001 (HBM)		V_{ESD}	8	kV
ESD withstand Voltage ANSI/ESDA/JEDEC JS-002 (CDM)		V_{CDM}	1	

Notes:

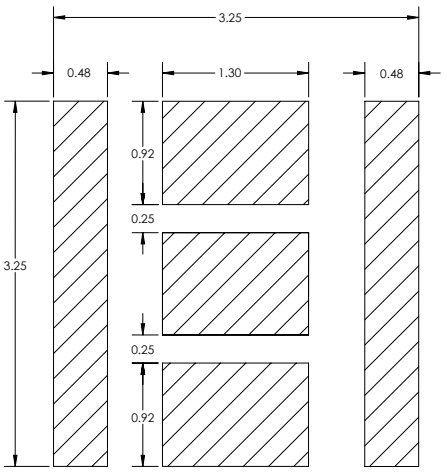
1. The LED is safe for operation at the absolute maximum ratings as specified above. However, note that product lifetime data is provided based on nominal drive conditions. If sustained operation occurs at the absolute maximum ratings, it may lead to a reduction in device lifetime.
2. Avoid operating the LED beyond the maximum ratings.

Mechanical Dimensions[1]





RECOMMENDED PCB SOLDER PAD DESIGN



RECOMMENDED STENCIL PATTERN DESIGN

Note:

1. All dimensions are in millimeter ± 0.13 mm.

Mechanical Characteristics

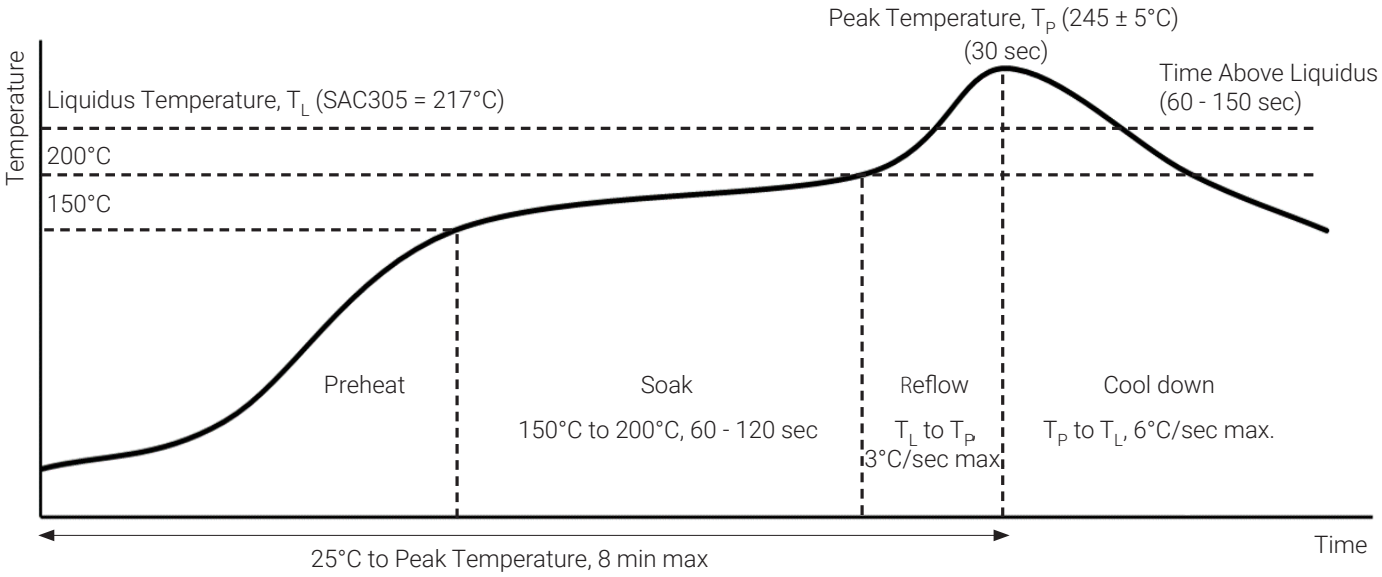
JEDEC Moisture Sensitivity[1,]

Level	Floor Life	
	Time	Conditions
3	168 Hours	≤30°C / 60% RH

Notes:

1. Please note that the above MSL level based on the MSL qualification rating.

Soldering Profile



SMT Solder Rework Temperature Guidelines

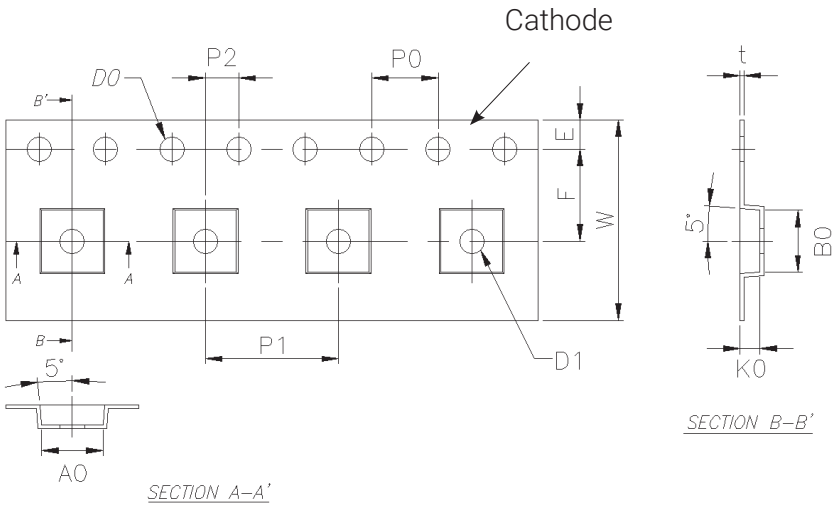
Parameter	Manual Hotplate Reflow	Hot Air Gun Reflow
Heating Time	< 60 sec	
Hotplate Temperature	< 245°C	< 150°C

Notes:

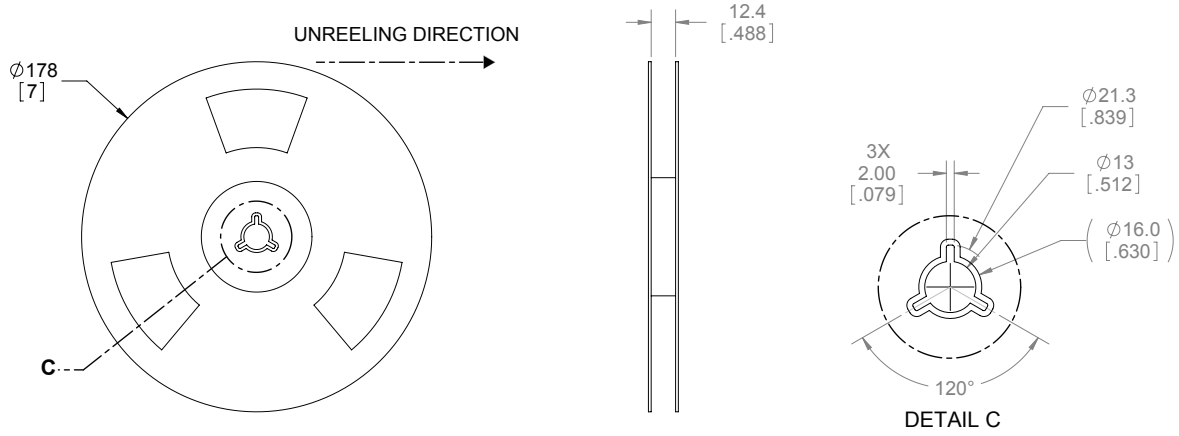
1. The numbers in the table are specific to SAC305. Luminus recommends using an SAC305 solder paste with a no-clean flux for RoHS compliant products.
2. Use of a multi-zone IR reflow oven with a nitrogen blanket is recommended.
3. Time-temperature profile of the reflow process showing the four functional profile zones are defined in IPC-7801. All the temperatures refer to the application PCB measured adjacent to the package body.
4. The actual profile shall be optimized per the PCB design and configuration.
5. Key visual and LED performance characteristics to consider include solder bridging, solder voiding, solder balling, LED component placement or shifting, potential contamination that may impact light emissions, and the functional performance of the LED.
6. Luminus recommends to use the solder paste data sheet information as a starting point in time-temperature process development.
7. These are general guidelines. Consult the solder paste manufacturer's datasheet for guidelines specific to the alloy and flux combination used in your application. For more information, please refer to:

   https://luminusdevices.zendesk.com/hc/en-us/articles/360060306692-How-do-I-Reflow-Solder-Luminus-SMD-Components-
8. For any technical questions about soldering process, please contact Luminus at techsupport@luminus.com.

Tape and Reel Outline



Parameter	Dimension (mm)
A0	3.70±0.10
B0	3.70±0.10
D0	1.50+0.10
D1	1.50±0.10
E	1.75±0.10
F	5.50±0.10
K0	1.20±0.10
P0	4.00±0.10
P1	8.00±0.10
P2	2.00±0.10
t	0.23±0.05
W	12±0.3

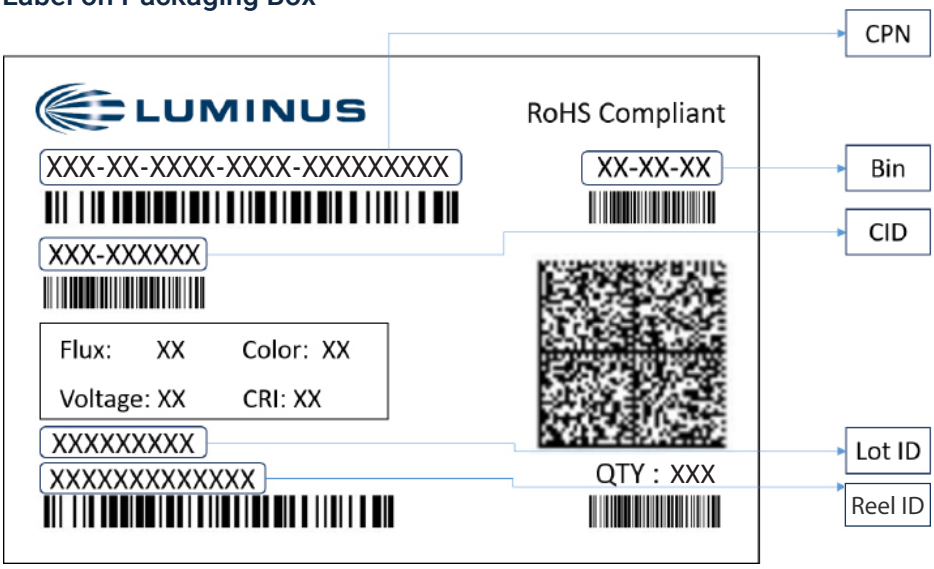


Notes:

1. Each Reel contains 500 units of LEDs.
2. Black ant-static tape material (Denka ECMB/ECAP3).
3. The accumulated tolerance for ten chain holes should be no more than 0.2 mm.
4. The tortuosity of 250 mm tape should be no more than 1 mm.
5. Leave minimum 800 mm with empty compartments sealed by cover tape for lead in.
6. Leave minimum 1200 mm with empty compartments sealed by cover tape for trailer.
7. All dimensions must comply to EIA-481-D
8. Final tape and reel packaging must meet the requirements of JEDEC-STD-033, LEVEL 2A.

Shipping Label

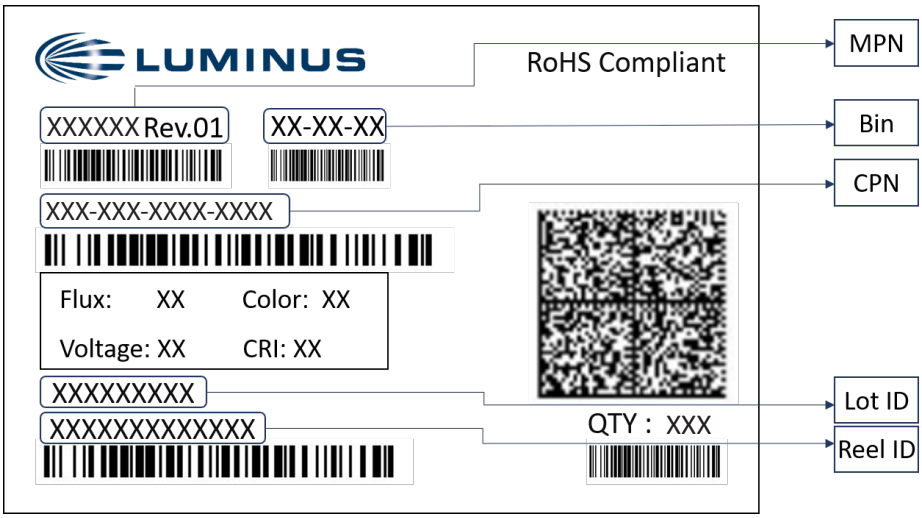
Label on Packaging Box



Label Fields:

CPN: Luminus ordering part number
CID: Customer's part number
QTY: Quantity of parts per reel
Flux: Bin as defined on page 3
Voltage: Bin as defined on page 3
Color: Bin as defined on page 4 - 6
CRI: NA
Lot ID & Reel ID: For Luminus internal use

Label on Reel

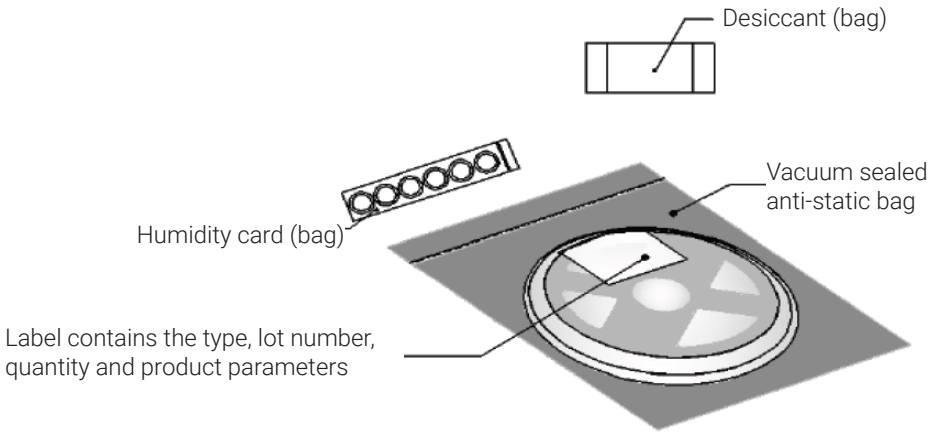


Label Fields:

CPN: Luminus ordering part number
MPN: For Luminus internal use
QTY: Quantity of parts per reel
Flux: Bin as defined on page 3
Voltage: Bin as defined on page 3
Color: Bin as defined on page 4 - 6
CRI: NA
Lot ID & Reel ID: For Luminus internal use

Packaging

Packaged Reel



Notes

Environmental Compliance

Luminus complies with RoHS and REACH. Luminus is committed to selling environmentally friendly and sustainable products. We do not use harmful or hazardous substances in our composites and products. Luminus will not intentionally add the following restricted materials to our products: lead, mercury, cadmium, hexavalent chromium, polybrominated biphenyls (PBB), or polybrominated diphenyl ethers (PBDE).

Static Electricity

1. The products are sensitive to static electricity, and care should be taken when handling them.
2. Static electricity or surge voltage will damage the LEDs. It is recommended to wear anti-electrostatic gloves or a wristband when handling the LEDs.
3. All devices, equipment and machinery must be properly grounded. It is recommended that measures be taken against surge voltage to the equipment that mounts the LEDs.

Reference: APN-002815 Electrical Stress Damage to LEDs and How to Prevent It

Storage

Please follow J-STD-033D guidance on safe storage and bake treatment.

1. Before opening the package

   The LEDs should be kept at a temperature lower than 40°C and relative humidity lower than 90%. The LEDs should be used within a year. When storing the LEDs, moisture proof package with absorbent material (silica gel) is recommended.

2. After opening the package

   The LEDs should be kept at a temperature lower than 30°C and relative humidity lower than 60%. The LEDs should be soldered within 168 hours (7 days) after opening the moisture proof package.

   If unused LEDs remain, they should be stored in moisture proof packages, such as sealed containers with moisture absorbent material (silica gel). It is also recommended to return the unused LEDs to the original moisture proof package and to seal it again.

   If the moisture absorbent material (silica gel) vaporizes or passes the expiration date, baking treatment should be performed by using the following conditions : 60°C for 20 hours.

   The LED's electrode and lead frame comprise a silver plated copper alloy. The silver surface may be affected by environments. Please avoid conditions which may cause the LEDs to corrode or discolor. The corrosion or discoloration might lower solderability or affect optical characteristics.

   Please avoid rapid transition in ambient temperature, especially in high humidity environments where condensation can occur.